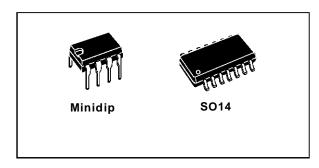
UC2842/3/4/5 UC3842/3/4/5

CURRENT MODE PWM CONTROLLER

- OPTIMIZED FOR OFF-LINE AND DC TO DC CONVERTERS
- LOW START-UP CURRENT (< 1 mA)
- AUTOMATIC FEED FORWARD COMPENSA-TION
- PULSE-BY-PULSE CURRENT LIMITING
- ENHANCED LOAD RESPONSE CHARAC-TERISTICS
- UNDER-VOLTAGE LOCKOUT WITH HYSTER-ESIS
- DOUBLE PULSE SUPPRESSION
- HIGH CURRENT TOTEM POLE OUTPUT
- INTERNALLY TRIMMED BANDGAP REFER-ENCE
- 500 KHz OPERATION
- LOW Ro ERROR AMP

DESCRIPTION

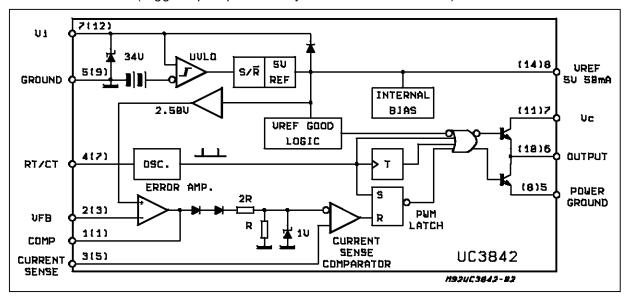
The UC3842/3/4/5 family of control ICs provides the necessary features to implement off-line or DC to DC fixed frequency current mode control schemes with a minimal external parts count. Internally implemented circuits include under voltage lockout featuring start-up current less than 1 mA, a precision reference trimmed for accuracy at the error amp input,



logic to insure latched operation, a PWM comparator which also provides current limit control, and a totem pole output stage designed to source or sink high peak current. The output stage, suitable for driving N-Channel MOSFETs, is low in the off-state.

Differences between members of this family are the under-voltage lockout thresholds and maximum duty cycle ranges. The UC3842 and UC3844 have UVLO thresholds of 16V (on) and 10V (off), ideally suited off-line applications The corresponding thresholds for the UC3843 and UC3845 are 8.5 V and 7.9 V. The UC3842 and UC3843 can operate to duty cycles approaching 100%. A range of the zero to < 50 % is obtained by the UC3844 and UC3845 by the addition of an internal toggle flip flop which blanks the output off every other clock cycle.

BLOCK DIAGRAM (toggle flip flop used only in U3844 and UC3845)



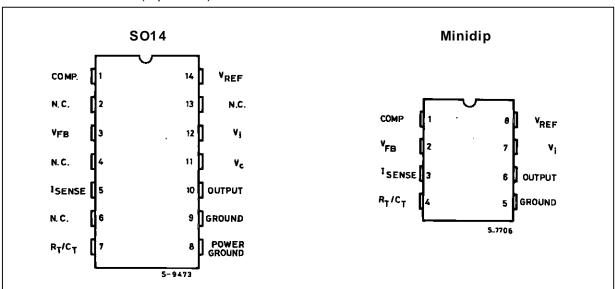
May 1995 1/11

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vi	Supply Voltage (low impedance source)	30	V
Vi	Supply Voltage (li < 30mA)	Self Limiting	
Ιο	Output Current	±1	Α
Eo	Output Energy (capacitive load)	5	μJ
	Analog Inputs (pins 2, 3)	-0.3 to 6.3	V
	Error Amplifier Output Sink Current	10	mA
P _{tot}	Power Dissipation at T _{amb} ≤ 50 °C (minidip, DIP-14)	1	W
P _{tot}	Power Dissipation at Tamb ≤ 25 °C (SO14)	725	mW
T _{stg}	Storage Temperature Range	-65 to 150	°C
T_L	Lead Temperature (soldering 10s)	300	°C

^{*} All voltages are with respect to pin 5, all currents are positive into the specified terminal.

PIN CONNECTIONS (top views)



ORDERING NUMBERS

Туре	Minidip	SO14
UC2842	UC2842N	UC2842D
UC3843	UC2843N	UC2843D
UC2844	UC2844N	UC2844D
UC2845	UC2845N	UC2845D
UC3842	UC3842N	UC3842D
UC3843	UC3843N	UC3843D
UC3844	UC3844N	UC3844D
UC3845	UC3845N	UC3845D

THERMAL DATA

Symbol	Description	Minidip	SO14	Unit
R _{th j-amb}	Thermal Resistance Junction-ambient. ma	. 100	165	°C



ELECTRICAL CHARACTERISTICS (Unless otherwise stated, these specifications apply for $-25 \le T_{amb} \le 85^{\circ}\text{C}$ for UC2824X; $0 \le T_{amb} \le 70^{\circ}\text{C}$ for UC384X; $V_i = 15\text{V}$ (note 5); $R_T = 10\text{K}$; $C_T = 3.3\text{nF}$)

0	Danassatas	UC284X			Total Quality UC284X U		JC384X		IImit	
Symbol	Parameter	Test Conditions		Тур.				Max.	Unit	
		REFERENCE SECTION			•	•		•		
V_{REF}	Output Voltage	$T_j = 25^{\circ}C$ $I_0 = 1mA$	4.95	5.00	5.05	4.90	5.00	5.10	V	
ΔV_{REF}	Line Regulation	$12V \le V_i \le 25V$		6	20		6	20	mV	
ΔV_{REF}	Load Regulation	$1 \le I_0 \le 20 \text{mA}$		6	25		6	25	mV	
$\Delta V_{REF}/\Delta T$	Temperature Stability	(Note 2)		0.2	0.4		0.2	0.4	mV/°C	
	Total Output Variant	Line, Load, Temperature (2)	4.9		5.1	4.82		5.18	V	
e _N	Output Noise Voltage	$10Hz \le f \le 10KHz T_j = 25^{\circ}C$ (2)		50			50		μV	
	Long Term Stability	$T_{amb} = 125^{\circ}C, 1000Hrs (2)$		5	25		5	25	mV	
I _{SC}	Output Short Circuit		-30	-100	-180	-30	-100	-180	mA	
		OSCILLATOR SECTION								
fs	Initial Accuracy	$T_j = 25^{\circ}C$ (6)	47	52	57	47	52	57	KHz	
	Voltage Stability	$12 \leq V_i \leq 25V$		0.2	1		0.2	1	%	
	Temperature Stability	$T_{MIN} \le T_{amb} \le T_{MAX}$ (2)		5			5		%	
V ₄	Amplitude	V _{PIN4} Peak to Peak		1.7			1.7		V	
		ERROR AMP SECTION								
V ₂	Input Voltage	V _{PIN1} = 2.5V	2.45	2.50	2.55	2.42	2.50	2.58	V	
I _b	Input Bias Current			-0.3	-1		-0.3	-2	μΑ	
	Avol	$2 \le V_0 \le 4V$	65	90		65	90		dB	
В	Unity Gain Bandwidth	(2)	0.7	1		0.7	1		MHz	
SVR	Supply Voltage Rejection	$12V \le V_i \le 25V$	60	70		60	70		dB	
Ιο	Output Sink Current	VPIN2 = 2.7V VPIN1 = 1.1V	2	6		2	6		V	
Ιο	Output Source Current	VPIN2 = 2.3V VPIN1 = 5V	-0.5	-0.8		-0.5	-0.8		mA	
	V _{OUT} High	$V_{PIN2} = 2.3V;$ $R_L = 15K\Omega$ to Ground	5	6		5	6		V	
	V _{OUT} Low	$V_{PIN2} = 2.7V;$ $R_L = 15K\Omega$ to Pin 8		0.7	1.1		0.7	1.1	>	
		CURRENT SENSE SECTION	ON							
Gv	Gain	(3 & 4)	2.85	3	3.15	2.8	3	3.2	V/V	
V ₃	Maximum Input Signal	V _{PIN1} = 5V (3)	0.9	1	1.1	0.9	1	1.1	V	
SVR	Supply Voltage Rejection	12 ≤ V _i ≤ 25V (3)		70			70		dB	
Ι _b	Input Bias Current			-2	-10		-2	-10	μΑ	
	Delay to Output			150	300		150	300	ns	
		OUTPUT SECTION								
I _{OL}	Output Low Level	I _{SINK} = 20mA		0.1	0.4		0.1	0.4	V	
		I _{SINK} = 200mA		1.5	2.2		1.5	2.2	V	
Іон	Output High Level	ISOURCE = 20mA	13	13.5		13	13.5		V	
		Isource = 200mA	12	13.5		12	13.5		V	
t _r	Rise Time	$T_j = 25^{\circ}C$ $C_L = 1nF$ (2)		50	150		50	150	ns	
t _f	Fall Time	$T_j = 25^{\circ}C$ $C_L = 1nF$ (2)		50	150		50	150	ns	
		<u> </u>								

ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Conditions	ι	UC284X			UC384X			
	rarameter	rest conditions		Тур.	Max.	Min.	Тур.	Max.	Unit	
	UNDER-VOLTAGE LOCKOUT SECTION									
	Start Threshold	X842/4	15	16	17	14.5	16	17.5	V	
		X843/5	7.8	8.4	9.0	7.8	8.4	9	V	
	Min Operating Voltage	X842/4	9	10	11	8.5	10	11.5	V	
	After Turn-on	X843/5	7.0	7.6	8.2	7.0	7.6	8.2	V	
	PWM SECTION									
	Maximum Duty Cycle	X842/3	93	97	100	93	97	100	%	
		X844/5	46	48	50	47	48	50	%	
	Minimum Duty Cycle				0			0	%	
	TOTAL STANDBY CURRENT									
I _{st}	Start-up Current			0.5	1		0.5	1	mA	
li	Operating Supply Current	V _{PIN2} = V _{PIN3} = 0V		11	20		11	20	mA	
V _{iz}	Zener Voltage	l _i = 25mA		34			34		V	

Notes: 2. These parameters, although guaranteed, are not 100% tested in production.

$$A = \frac{\Delta V_{PIN1}}{\Delta V_{PIN3}} ; 0 \le V_{PIN3} \le 0.8 V$$

^{3.} Parameter measured at trip point of latch with $V_{PIN2} = 0$.

^{4.} Gain defined as:

^{5.} Adjust Vi above the start threshold before setting at 15 V.
6. Output frequency equals oscillator frequency for the UC3842 and UC3843.
Output frequency is one half oscillator frequency for the UC3844 and UC3845.

Figure 1 : Error Amp Configuration.

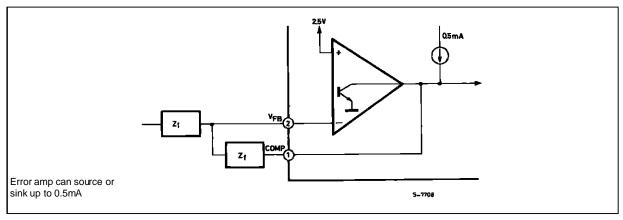
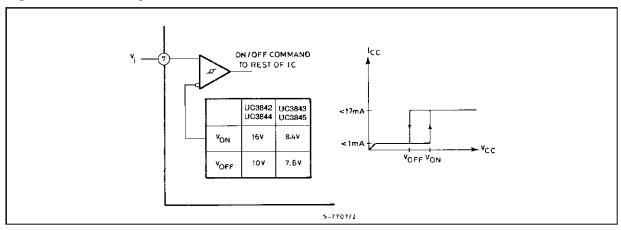


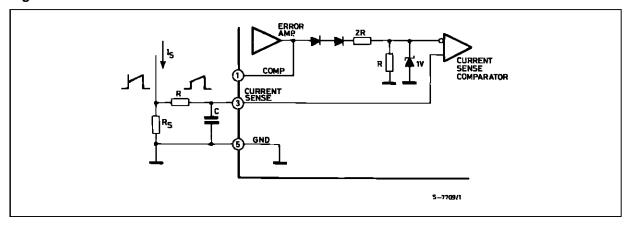
Figure 2: Under Voltage Lockout.



During Under-Voltage Lockout, the output driver is biased to sink minor amounts of current. Pin 6 should be shunted to ground with a bleeder resistor

to prevent activating the power switch with extraneous leakage currents.

Figure 3: Current Sense Circuit.



Peak current (is) is determined by the formula

$$I_{S \text{ max}} \approx \frac{1.0 \text{ V}}{R_{S}}$$

A small RC filter may be required to suppress switch transients.

Figure 4.

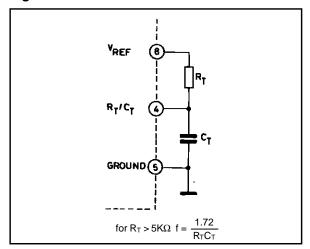


Figure 6: Timing Resistance vs. Frequency.

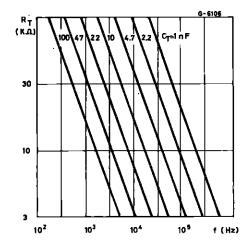


Figure 8 : Error Amplifier Open-loop Frequency Response.

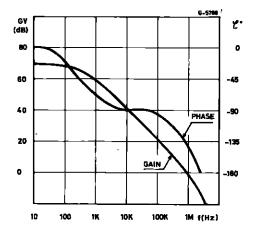


Figure 5 : Deadtime vs. C_T ($R_T > 5K\Omega$).

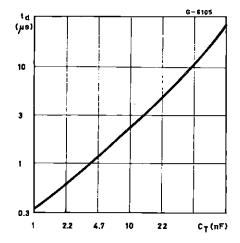


Figure 7: Output Saturation Characteristics.

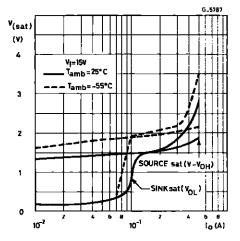
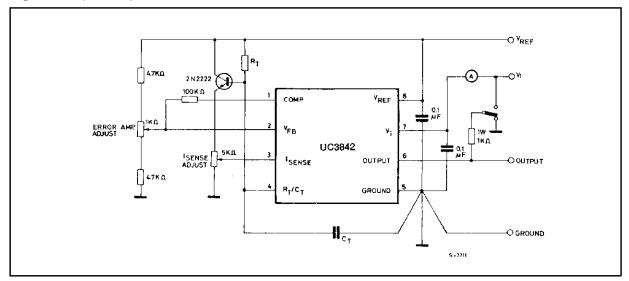
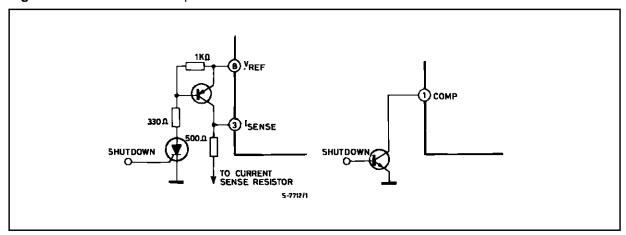


Figure 9: Open Loop Test Circuit.



High peak currents associated with capacitive loads necessitate careful grounding techniques. Timing and bypass capacitors should be connected close to pin 5 in a single point ground. The transistor and $5 \text{ K}\Omega$ potentiometer are used to sample the oscillator waveform and apply an adjustable ramp to pin 3.

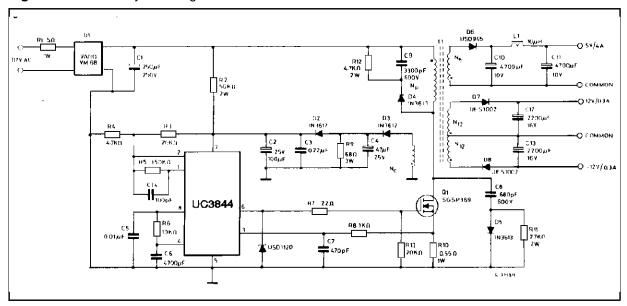
Figure 10: Shutdown Techniques.



Shutdown of the UC2842 can be accomplished by two methods; either raise pin 3 above 1V or pull pin 1 below a voltage two diode drops above ground. Either method cause the output of the PWM comparator to be high (refer to block diagram). The PWM latch is reset dominant so that the output will remain low until the next clock cycle after the shut-

down condition at pins 1 and/or 3 is removed. In one example, an externally latched shutdown may be accomplished by adding an SCR which will be reset by cycling V_i below the lower UVLO threshold. At this point the reference turns off, allowing the SCR to reset.

Figure 11: Off-line Flyback Regulator.



Power Supply Specifications

1. Input Voltage: 95 VAC to 130 VAC

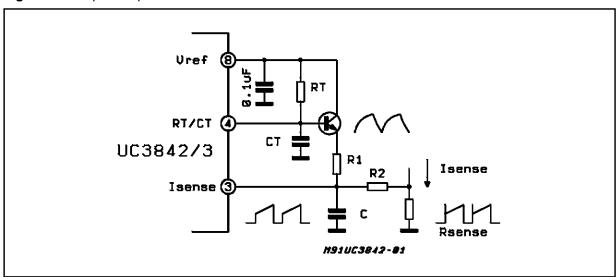
(50 Hz/60 Hz)

Line Isolation: 3750 V
 Switching Frequency: 40 KHz
 Efficiency @ Full Load: 70 %

5. Output Voltage:

A. + 5 V, \pm 5 %: 1 A to 4 A load Ripple voltage: 50 mV P-P Max. B. + 12 V, \pm 3 %: 0.1 A to 0.3 A load Ripple voltage: 100 mV P-P Max. C. - 12 V, \pm 3 %: 0.1 A to 0.3 A load Ripple voltage: 100 mV P-P Max.

Figure 12: Slope Compensation.

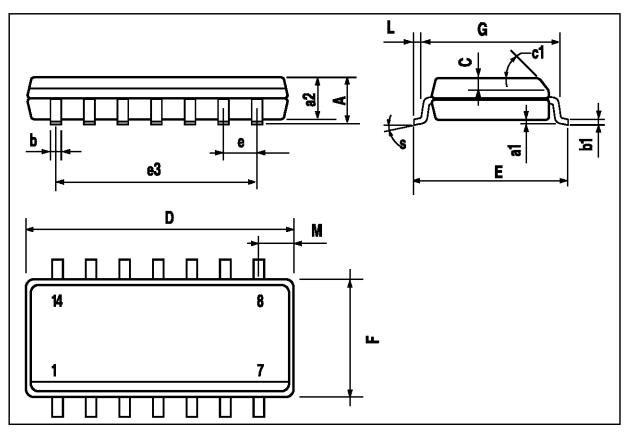


A fraction of the oscillator ramp can be resistively summed with the current sense signal to provide slope compensation for converters requiring duty cycles over 50 %.

Note that capacitor, C, forms a filter with R₂ to supress the leading edge switch spikes.

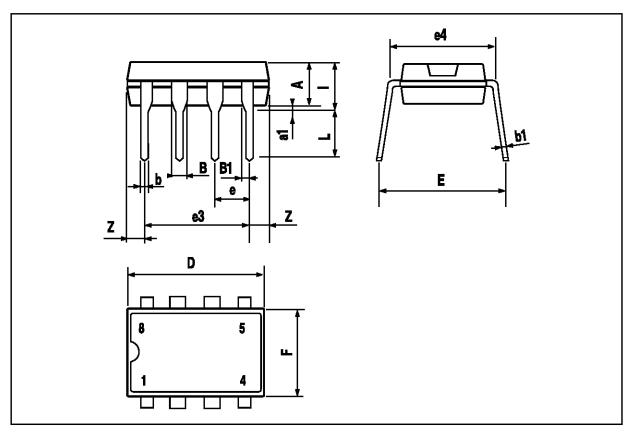
SO14 PACKAGE MECHANICAL DATA

DIM.		mm			inch			
DIW.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
Α			1.75			0.069		
a1	0.1		0.25	0.004		0.009		
a2			1.6			0.063		
b	0.35		0.46	0.014		0.018		
b1	0.19		0.25	0.007		0.010		
С		0.5			0.020			
c1			45 ((typ.)				
D	8.55		8.75	0.336		0.344		
E	5.8		6.2	0.228		0.244		
е		1.27			0.050			
e3		7.62			0.300			
F	3.8		4.0	0.15		0.157		
L	0.4		1.27	0.016		0.050		
М			0.68			0.027		
S	8 (max.)							



DIP14 PACKAGE MECHANICAL DATA

DIM.		mm			inch	
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А		3.32			0.131	
a1	0.51			0.020		
В	1.15		1.65	0.045		0.065
b	0.356		0.55	0.014		0.022
b1	0.204		0.304	0.008		0.012
D			10.92			0.430
E	7.95		9.75	0.313		0.384
е		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			6.6			0.260
I			5.08			0.200
L	3.18		3.81	0.125		0.150



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